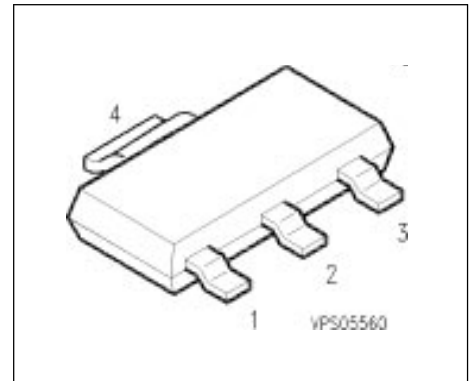


SIPMOS[®] Small-Signal Transistor

- P channel
- Enhancement mode
- Logic Level
- $V_{GS(th)} = -0.8...-2.0$ V



Pin 1	Pin 2	Pin 3	Pin 4
G	D	S	D

Type	V_{DS}	I_D	$R_{DS(on)}$	Package	Marking
BSP 316	-100 V	-0.65 A	2.2 Ω	SOT-223	BSP 316
Type	Ordering Code	Tape and Reel Information			
BSP 316	Q67000-S92	E6327			

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain source voltage	V_{DS}	-100	V
Drain-gate voltage $R_{GS} = 20$ k Ω	V_{DGR}	-100	
Gate source voltage	V_{GS}	± 20	
Continuous drain current $T_A = 24$ °C	I_D	-0.65	A
DC drain current, pulsed $T_A = 25$ °C	I_{Dpuls}	-2.6	
Power dissipation $T_A = 25$ °C	P_{tot}	1.8	W

Maximum Ratings

Parameter	Symbol	Values	Unit
Chip or operating temperature	T_j	-55 ... + 150	°C
Storage temperature	T_{stg}	-55 ... + 150	
Thermal resistance, chip to ambient air	R_{thJA}	≤ 70	K/W
Thermal resistance, junction-soldering point ¹⁾	R_{thJS}	≤ 10	
DIN humidity category, DIN 40 040		E	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

1) Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm² copper area for drain connection

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}, I_D = -0.25 \text{ mA}, T_j = 25 \text{ }^\circ\text{C}$	$V_{(BR)DSS}$	-100	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = -1 \text{ mA}$	$V_{GS(th)}$	-0.8	-1.1	-2	
Zero gate voltage drain current $V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 \text{ }^\circ\text{C}$ $V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 125 \text{ }^\circ\text{C}$ $V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 \text{ }^\circ\text{C}$	I_{DSS}	-	-0.1 -10 -	-1 -100 -100	μA nA
Gate-source leakage current $V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	I_{GSS}	-	-10	-100	nA
Drain-Source on-state resistance $V_{GS} = -10 \text{ V}, I_D = -0.65 \text{ A}$	$R_{DS(on)}$	-	1.4	2.2	Ω

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Dynamic Characteristics

Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}, I_D = -0.65 \text{ A}$	g_{fs}	0.25	0.45	-	S
Input capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{iss}	-	280	370	pF
Output capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{oss}	-	75	110	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{rss}	-	25	40	
Turn-on delay time $V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(on)}$	-	8	12	ns
Rise time $V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	t_r	-	30	45	
Turn-off delay time $V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(off)}$	-	80	110	
Fall time $V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	t_f	-	95	130	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

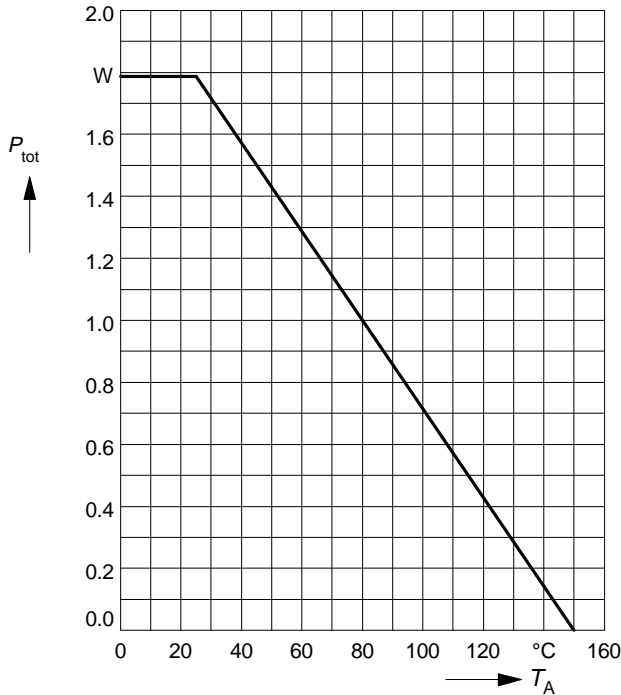
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Reverse Diode

Inverse diode continuous forward current $T_A = 25^\circ\text{C}$	I_S	-	-	-0.65	A
Inverse diode direct current, pulsed $T_A = 25^\circ\text{C}$	I_{SM}	-	-	-2.6	
Inverse diode forward voltage $V_{GS} = 0\text{ V}$, $I_F = -1.3\text{ A}$, $T_j = 25^\circ\text{C}$	V_{SD}	-	-1	-1.3	V

Power dissipation

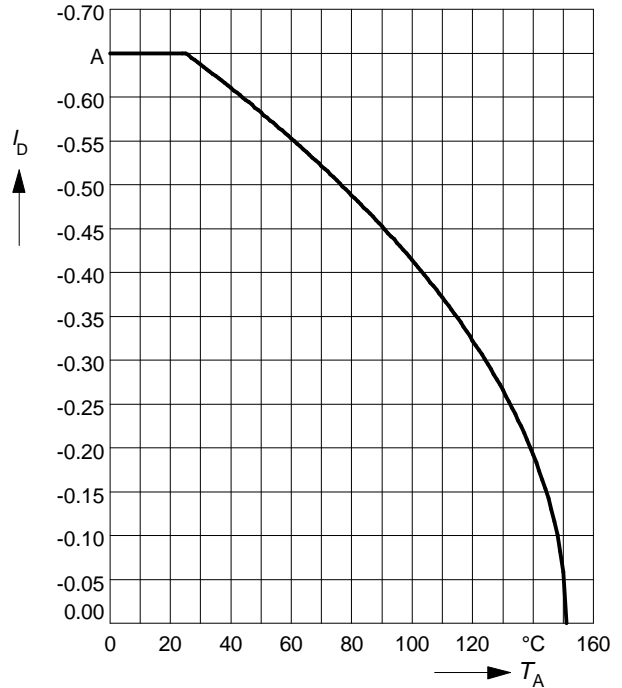
$$P_{\text{tot}} = f(T_A)$$



Drain current

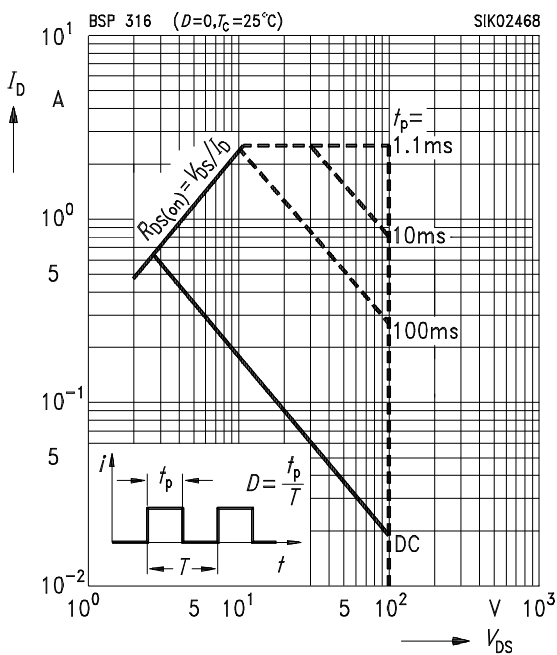
$$I_D = f(T_A)$$

parameter: $V_{GS} \geq -10 \text{ V}$



Safe operating area $I_D = f(V_{DS})$

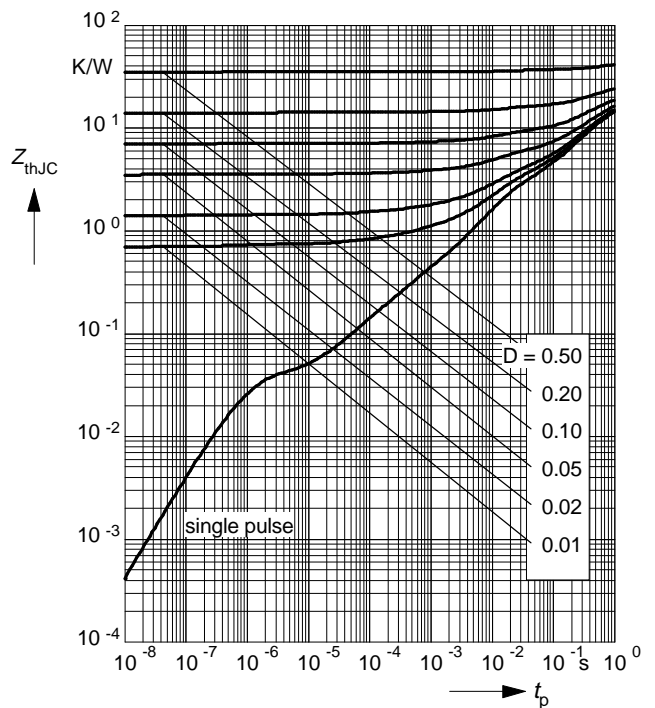
parameter: $D = 0, T_C = 25^\circ\text{C}$



Transient thermal impedance

$$Z_{\text{th JA}} = f(t_p)$$

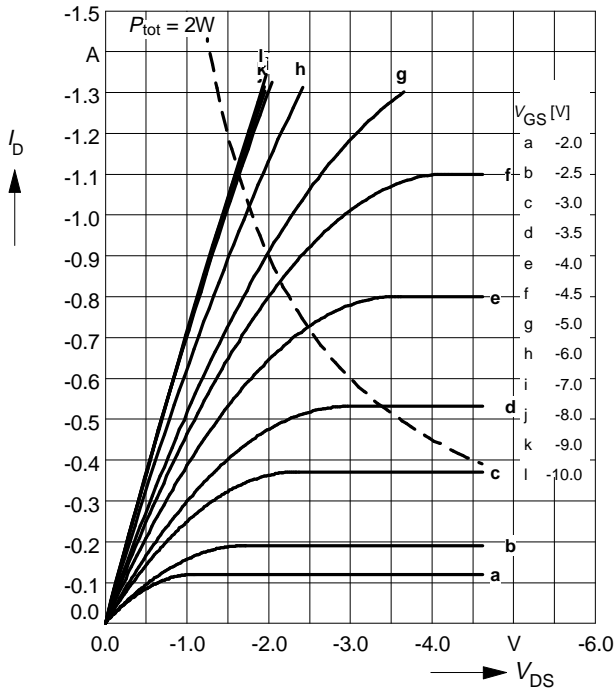
parameter: $D = t_p / T$



Typ. output characteristics

$$I_D = f(V_{DS})$$

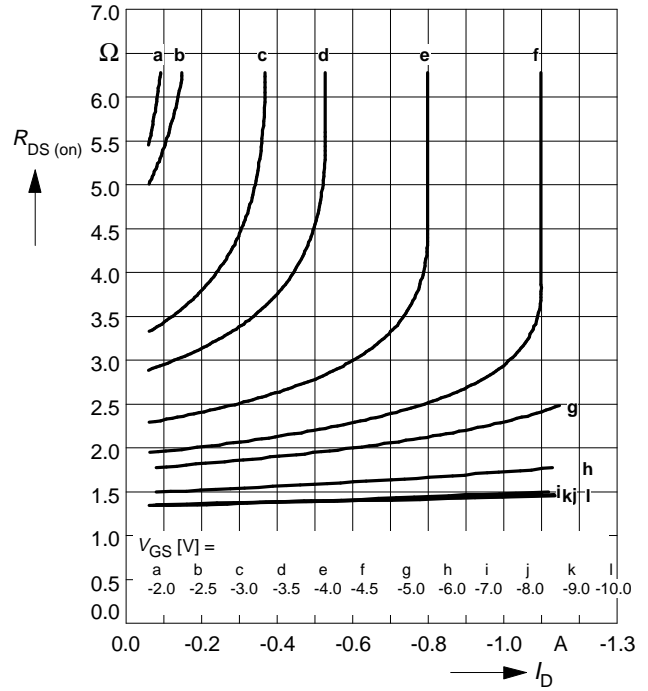
parameter: $t_p = 80 \mu s$



Typ. drain-source on-resistance

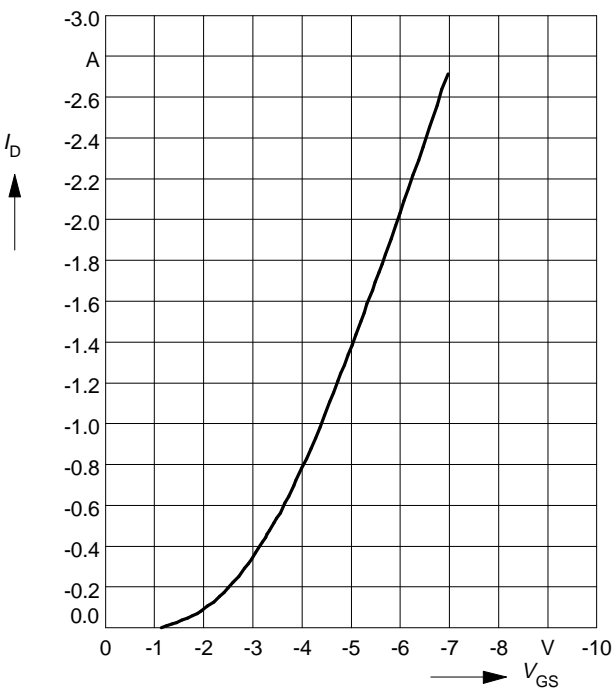
$$R_{DS(on)} = f(I_D)$$

parameter: $t_p = 80 \mu s, T_j = 25^\circ C$



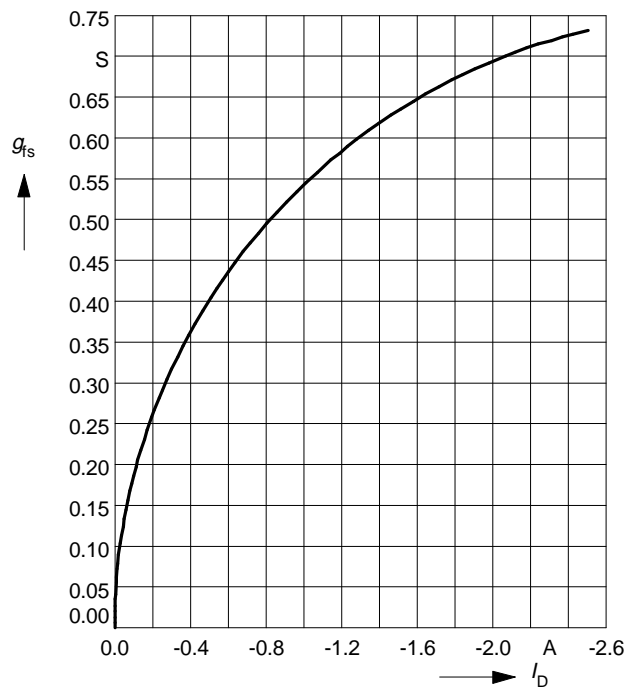
Typ. transfer characteristics $I_D = f(V_{GS})$

parameter: $t_p = 80 \mu s$



Typ. forward transconductance $g_{fs} = f(I_D)$

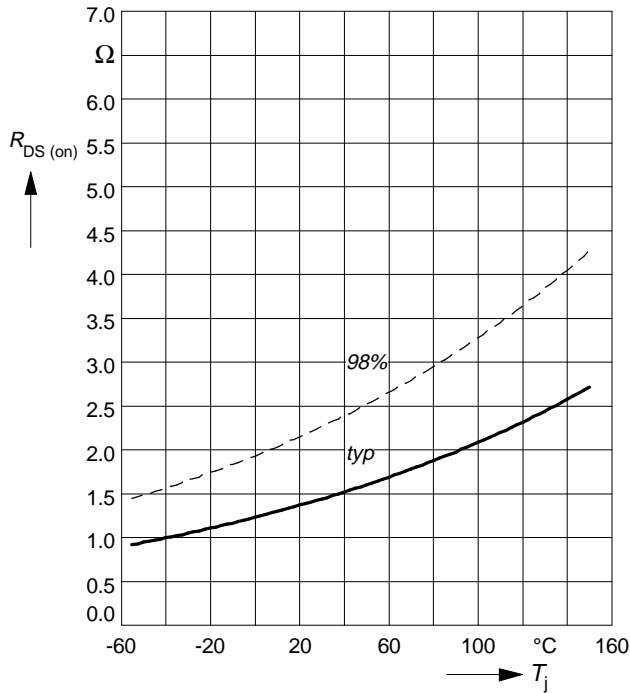
parameter: $t_p = 80 \mu s$



Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

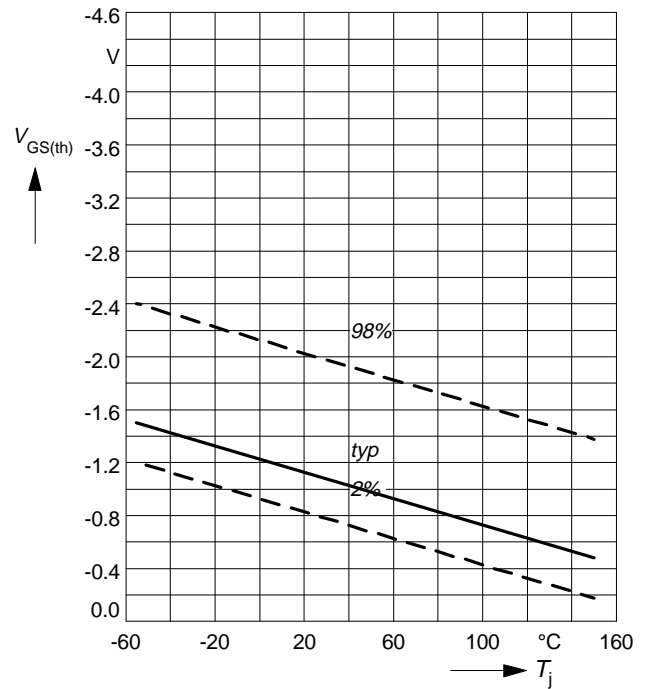
parameter: $I_D = -0.65 \text{ A}$, $V_{GS} = -10 \text{ V}$



Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

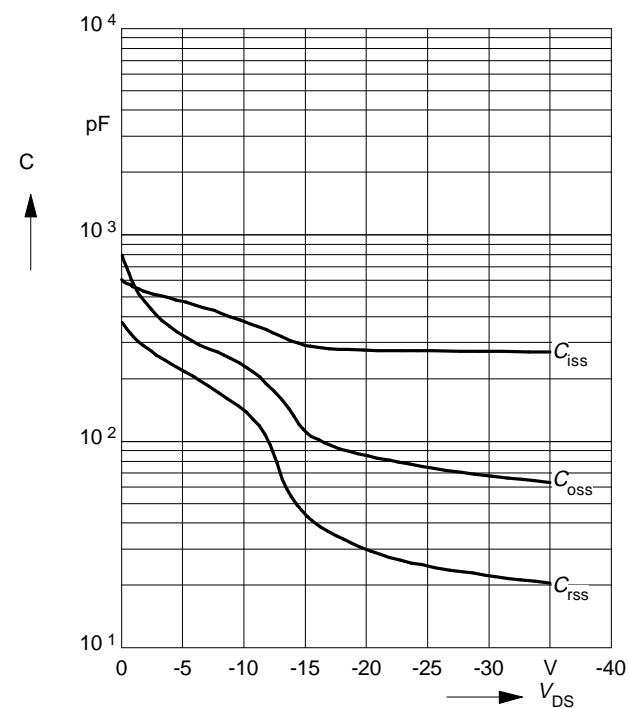
parameter: $V_{GS} = V_{DS}$, $I_D = -1 \text{ mA}$



Typ. capacitances

$$C = f(V_{DS})$$

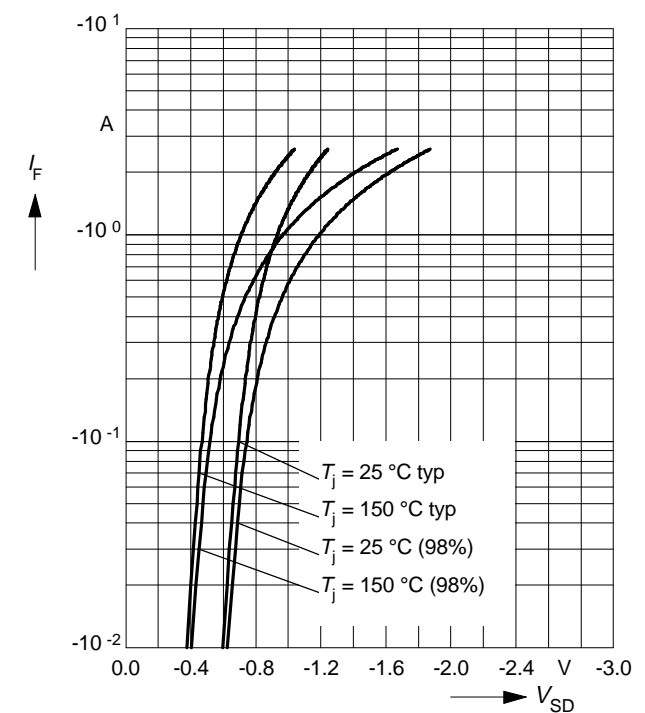
parameter: $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$



Forward characteristics of reverse diode

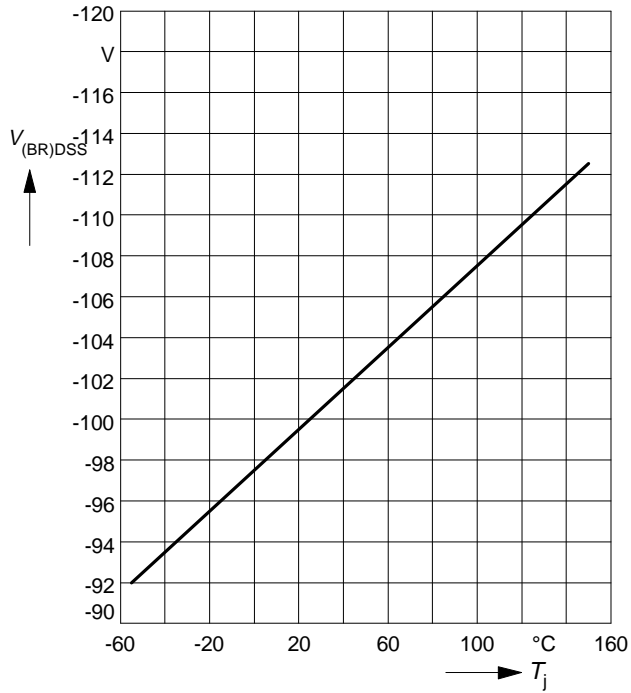
$$I_F = f(V_{SD})$$

parameter: T_j , $t_p = 80 \mu\text{s}$



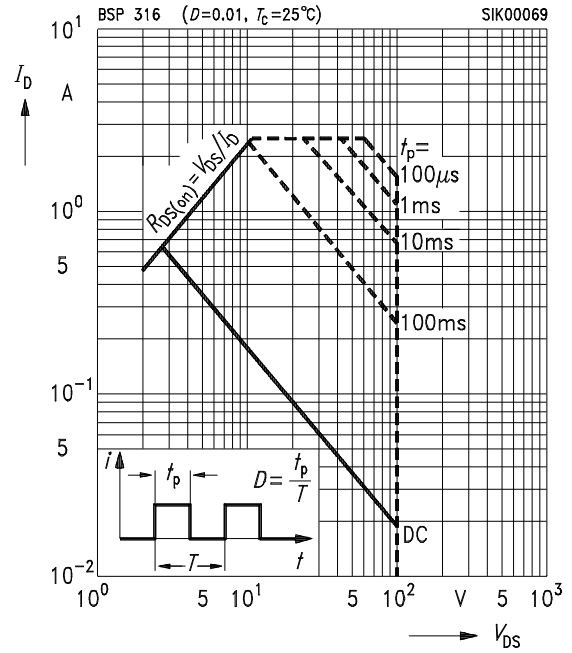
Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$



Safe operating area $I_D = f(V_{DS})$

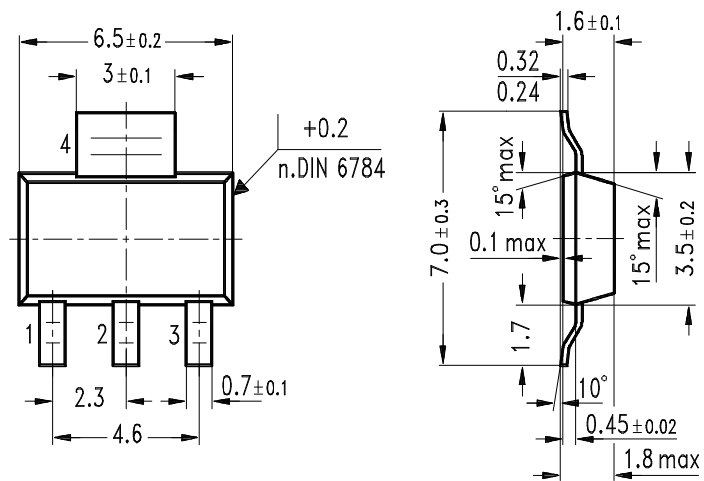
parameter : $D = 0.01$, $T_C = 25^\circ\text{C}$



Package outlines

SOT-223

Dimensions in mm



GPS05560